Huafon T25SYK

Polyamide 66

Huafon Group Co., Ltd.

Message:

T25SYK is semi-dull and middle-low viscosity resin, with good spinnability and dyeing properties. Typical Applications T25SYK is mainly used in POY filament, as well as fine denier textile yarn.

General Information				
Filler / Reinforcement	Titanium Dioxide,0.30% Filler by Weight			
Features	Medium-low Viscosity			
Uses	Filaments			
	Yarn			

Physical	Nominal Value	Unit	Test Method
Density	1.14	g/cm³	ISO 1183
Apparent Density	0.70	g/cm³	Internal Method
Particle Size	2.20 to 2.80	g/100 pellets	Internal Method
Relative Viscosity	2.42 to 2.50		Internal Method
Water Content	< 5000	mg/kg	Internal Method
Thermal	Nominal Value	Unit	Test Method
Peak Melting Temperature ¹	257	°C	ASTM D3418
NOTE			
1.	10°C/min		

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